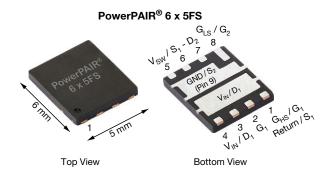
COMPLIANT

HALOGEN

**FREE** 

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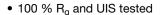
# Symmetric Dual N-Channel 40 V (D-S) MOSFET



PRODUCT SUMMARY				
V <sub>DS</sub> (V)	40			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.00137			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.00240			
Q <sub>g</sub> typ. (nC)	30			
I <sub>D</sub> (A) <sup>a</sup>	159			
Configuration	Dual			

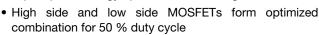
#### **FEATURES**

TrenchFET® Gen IV power MOSFET



• Symmetric dual N-channel

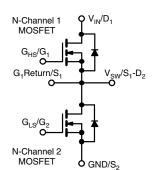
• Flip chip technology optimal thermal design



 Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

### **APPLICATIONS**

- Buck-boost
- Half-bridge synchronous rectification
- Telecom DC/DC
- Motor drive control



ORDERING INFORMATION				
Package	PowerPAIR 6 x 5FS			
Lead (Pb)-free and halogen-free	SiZF640DT-T1-GE3			

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	40	V	
Gate-source voltage		V <sub>GS</sub>	+20, -16	v	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		159		
	T <sub>C</sub> = 70 °C		127		
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	41 b, c		
	T <sub>A</sub> = 70 °C		33 b, c	•	
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	300	A	
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		57		
	T <sub>A</sub> = 25 °C	I <sub>S</sub>	3.8 b, c		
ingle pulse avalanche current		I <sub>AS</sub>	40		
Single pulse avalanche energy	L = 0.1 mH	E <sub>AS</sub>	80	mJ	
	T <sub>C</sub> = 25 °C		62.5		
Maximum power dissipation	T <sub>C</sub> = 70 °C	Б	40	w	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	4.2 <sup>b, c</sup>	VV	
	T <sub>A</sub> = 70 °C		2.7 b, c		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Soldering recommendations (peak temperature) d, e		Ü	260		

### Notes

- a.  $T_C = 25$  °C
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAIR is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

Document Number: 62022

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THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient a, b	t ≤ 10 s	R <sub>thJA</sub>	24	30	°C/W	
Maximum junction-to-case (source)	Steady state	$R_{thJC}$	1.6	2.0		

#### **Notes**

- a. Surface mounted on 1" x 1" FR4 board
- b. Maximum under steady state conditions is 60 °C/W for channel-1 and channel-2

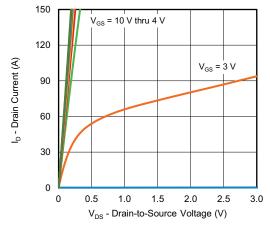
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	-						
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	40	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 10 mA		25.3	-		
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-5.5	-	mV/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1	-	2.4	V	
Gate-source leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = +20 V, -16 V	-	-	± 100	nA	
Zero gate voltage drain current		V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V	-	-	1	μΑ	
	I <sub>DSS</sub>	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C	-	-	10		
Due in a course on state westerness 2	Б	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A	-	0.0010	0.00137	_	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 15 \text{ A}$	-	0.0016	0.00240	Ω	
Forward transconductance a	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, I_D = 45 \text{ A}$	-	175	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>		-	5750	-	pF	
Output capacitance	C <sub>oss</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	960	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	55	-		
Tatal mate about	0	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 15 \text{ A}$	-	69	106	nC	
Total gate charge	$Q_g$	-	-	30	45		
Gate-source charge	$Q_{gs}$	$V_{DS} = 20 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 15 \text{ A}$	-	21	=		
Gate-drain charge	$Q_{gd}$		-	1.5	-		
Output charge	Q <sub>oss</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V	-	46	-		
Gate resistance	$R_g$	f = 1 MHz	0.4	1.7	3.4	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	18	40		
Rise time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, R_L = 2 \Omega, I_D \cong 10 \text{ A},$	-	45	90		
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	45	90		
Fall time	t <sub>f</sub>		-	6	12		
Turn-on delay time	t <sub>d(on)</sub>		-	50	100	ns -	
Rise time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, R_L = 2 \Omega, I_D \cong 10 \text{ A},$	-	115	230		
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	40	80		
Fall time	t <sub>f</sub>		-	10	20		
<b>Drain-Source Body Diode Characterist</b>	ics						
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	57	_	
Pulse diode forward current	I <sub>SM</sub>	-		-	300	A	
Body diode voltage	$V_{SD}$	I <sub>S</sub> = 10 A, V <sub>GS</sub> = 0 V	-	0.75	1.1	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	40	80	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	1 40 A 31/31 400 A / T 07 00	-	36	75	nC	
Reverse recovery fall time	t <sub>a</sub>	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$	-	25	-	ns	
Reverse recovery rise time	t <sub>b</sub>		-	15	-		

#### **Notes**

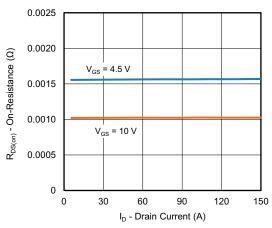
- c. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%$
- d. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

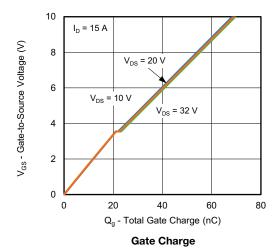


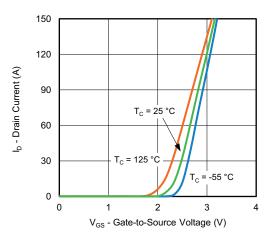


### **Output Characteristics**

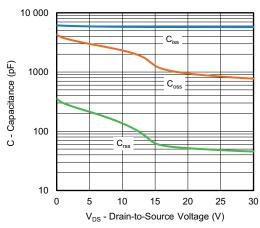


On-Resistance vs. Drain Current

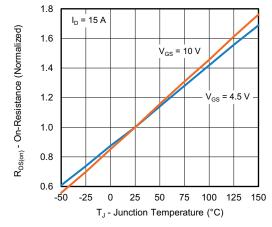




**Transfer Characteristics** 

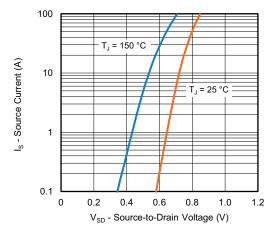


Capacitance

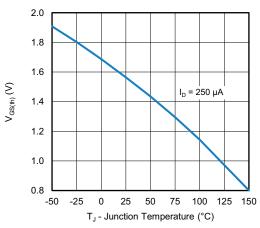


On-Resistance vs. Junction Temperature

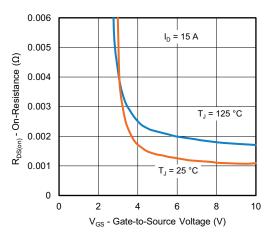




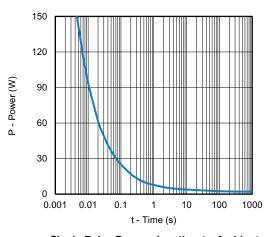
Source-Drain Diode Forward Voltage



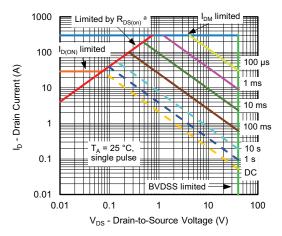
**Threshold Voltage** 



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

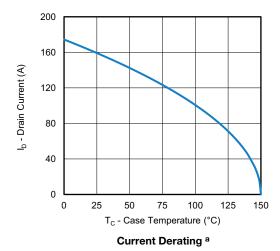


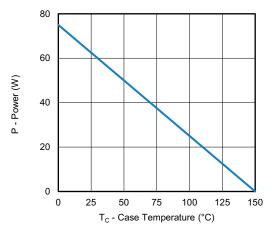
Safe Operating Area, Junction-to-Ambient

#### Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified





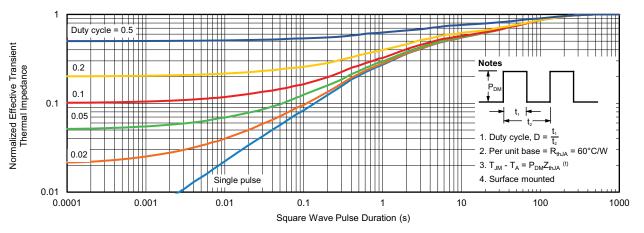


Power, Junction-to-Case

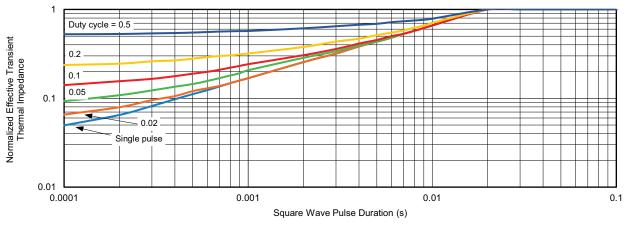
#### Note

b. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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